Emitter common(dual digital transistor)

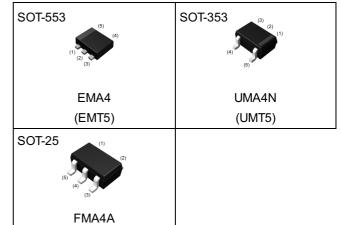
Datasheet

| Parameter | DTr1 and DTr2 |
|----------------|---------------|
| $V_{\sf CEO}$ | -50V |
| I _C | -100mA |
| R ₁ | 10kΩ |

Features

- 1)Two DTA114T chips in a EMT or UMT or SMT package.
- 2) Mounting cost and area can be cut in half.

Outline

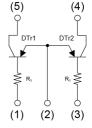


•Inner circuit

EMA4 / UMA4N

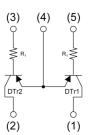
(SMT5)

- (1) DTr1 Base
- (2) DTr1 / DTr2 Emitter
- (3) DTr2 Base
- (4) DTr2 Collector
- (5) DTr1 Collector



FMA4A

- (1) DTr1 Collector
- (2) DTr2 Collector
- (3) DTr2 Base
- (4) DTr1 / DTr2 Emitter
- (5) DTr1 Base



Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|----------|-------------------|-----------------|----------------|-------------------|-----------------|---------------------------------|---------|
| EMA4 | SOT-553 (EMT5) | 1616 | T2R | 180 | 8 | 8000 | A4 |
| UMA4N | SOT-353 (UMT5) | 2021 | TR | 180 | 8 | 3000 | A4 |
| FMA4A | SOT-25 (SMT5) | 2928 | T148 | 180 | 8 | 3000 | A4 |

● Absolute maximum ratings (T_a = 25°C)

<For DTr1 and DTr2 in common>

| Parameter | | Symbol | Values | Unit | | |
|------------------------------|-------|------------------|---------------------|------|----------|--|
| Collector-base voltage | | V_{CBO} | -50 | V | | |
| Collector-emitter voltage | | V _{CEO} | -50 | V | | |
| Emitter-base voltage | | V _{EBO} | -5 | V | | |
| Collector current | | I _C | -100 | mA | | |
| | EMA4 | | P _D *1*2 | 150 | | |
| Power dissipation | UMA4N | | P _D *1*2 | 150 | mW/Total | |
| | FMA4A | | P _D *1*3 | 300 | | |
| Junction temperature | | Tj | 150 | °C | | |
| Range of storage temperature | | T _{stg} | -55 to +150 | °C | | |

● Electrical characteristics (T_a = 25°C)

<For DTr1 and DTr2 in common>

| Parameter | Cumbal | Conditions | Values | | | Unit | |
|--------------------------------------|----------------------|---|--------|------|------|-------|--|
| Parameter | | | Min. | Тур. | Max. | Orint | |
| Collector-base breakdown voltage | BV _{CBO} | I _C = -50μA | -50 | - | - | V | |
| Collector-emitter breakdown voltage | BV _{CEO} | BV _{CEO} I _C = -1mA | | - | - | V | |
| Emitter-base breakdown voltage | BV _{EBO} | I _E = -50μA | -5 | 1 | - | V | |
| | | V _{CB} = -50V | - | - | -500 | nA | |
| | | V _{EB} = -4V | 1 | 1 | -500 | nA | |
| Collector-emitter saturation voltage | V _{CE(sat)} | I _C = -10mA, I _B = -1mA | - | 1 | -300 | mV | |
| DC current gain | h _{FE} | $V_{CE} = -5V, I_{C} = -1mA$ | 100 | 250 | 600 | - | |
| Input resistance | R ₁ | - | 7 | 10 | 13 | kΩ | |
| Transition frequency | f _T *4 | V _{CE} = -10V, I _E = 5mA, f = 100MHz | - | 250 | - | MHz | |

^{*1} Each terminal mounted on a reference land.



^{*2 120}mW per element must not be exceeded.

^{*3 200}mW per element must not be exceeded.

^{*4} Characteristics of built-in transistor.

● Electrical characteristic curves (T_a = 25°C)

<For DTr1 and DTr2 in common>

Fig.1 Grounded Emitter Propagation Characteristics

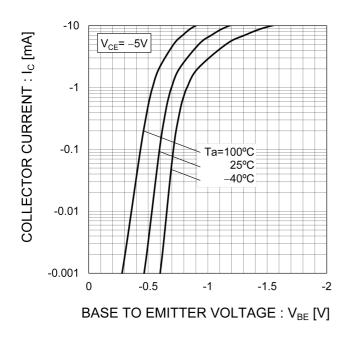


Fig.2 Grounded Emitter Output Characteristics

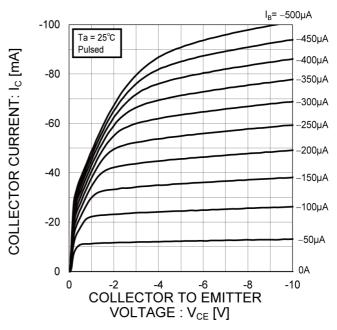


Fig.3 DC Current Gain vs. Collector Current

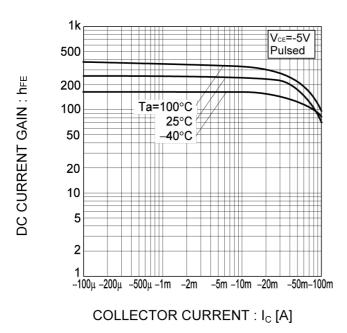
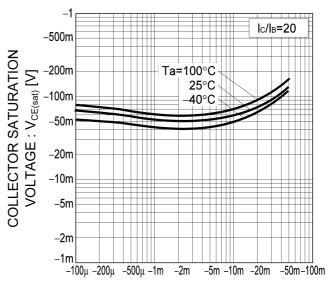
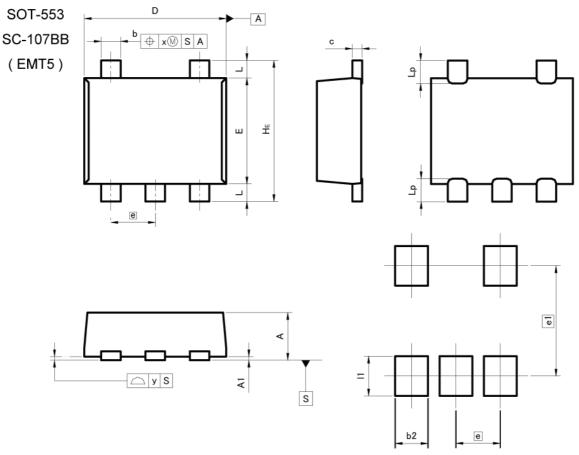


Fig.4 Collector-Emitter Saturation Voltage vs. Collector Current



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

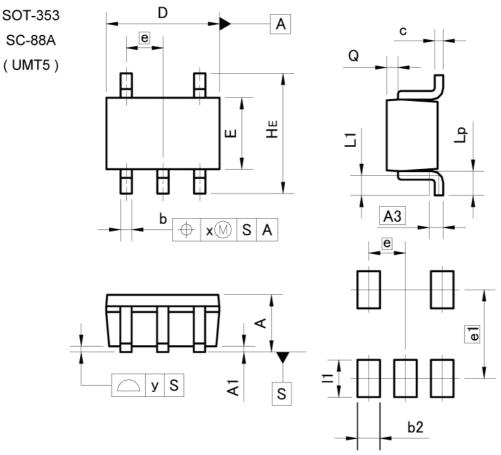
| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.45 | 0.55 | 0.018 | 0.022 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| b | 0.17 | 0.27 | 0.007 | 0.011 |
| С | 0.08 | 0.18 | 0.003 | 0.007 |
| D | 1.50 | 1.70 | 0.059 | 0.067 |
| E | 1.10 | 1.30 | 0.043 | 0.051 |
| е | 0. | 50 | 0.020 | |
| HE | 1.50 | 1.70 | 0.059 | 0.067 |
| L | 0.10 | 0.30 | 0.004 | 0.012 |
| Lp | _ | 0.35 | - | 0.014 |
| х | _ | 0.10 | _ | 0.004 |
| У | _ | 0.10 | _ | 0.004 |

| DIM | MILIMETERS MIN MAX | | INC | HES |
|------|--------------------|------|-----|-------|
| DIM | | | MIN | MAX |
| b2 | - | 0.37 | _ | 0.015 |
| e1 | 1.25 | | 0.0 | 49 |
| - 11 | _ | 0.45 | - | 0.018 |

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

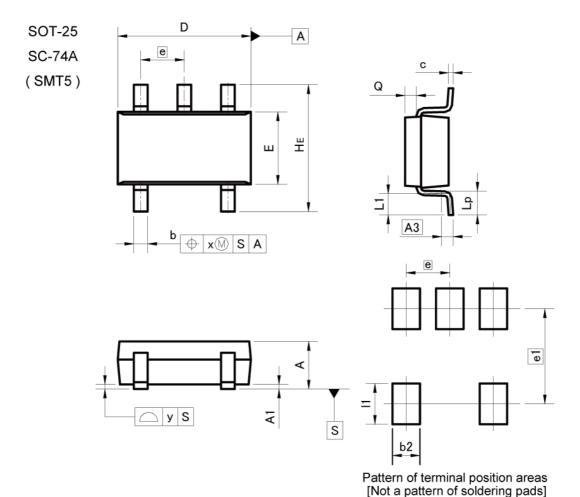
| DIM | MILIM | ETERS | INCHES | |
|-----|-------|-------|--------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.80 | 1.00 | 0.031 | 0.039 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A3 | 0.5 | 25 | 0.0 | 10 |
| b | 0.15 | 0.30 | 0.006 | 0.012 |
| С | 0.10 | 0.20 | 0.004 | 0.008 |
| D | 1.90 | 2.10 | 0.075 | 0.083 |
| E | 1.15 | 1.35 | 0.045 | 0.053 |
| е | 0.0 | 65 | 0.026 | |
| HE | 2.00 | 2.20 | 0.079 | 0.087 |
| L1 | 0.20 | 0.50 | 0.008 | 0.020 |
| Lp | 0.25 | 0.55 | 0.010 | 0.022 |
| Q | 0.10 | 0.30 | 0.004 | 0.012 |
| х | - | 0.10 | - | 0.004 |
| У | - | 0.10 | - | 0.004 |

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| MIN | | MAX | MIN | MAX |
| b2 | - 7 | 0.40 | j - | 0.016 |
| e1 | 1.55 | | 0.0 | 61 |
| 11 | | 0.65 | - | 0.026 |

Dimension in mm/inches



Dimensions



MILIMETERS INCHES DIM MIN MIN MAX MAX 0.051 1.30 0.039 Α 1.00 0.00 0.000 0.004 A1 0.10 0.25 0.010 A3 0.25 0.40 0.010 0.016 b С 0.09 0.25 0.004 0.010 D 2.80 3.00 0.110 0.118 Ε 1.50 1.80 0.059 0.071 е HE 2.60 3.00 0.102 0.118 L1 0.30 0.60 0.012 0.024 0.40 0.70 0.016 0.028 Lp 0.20 0.30 0.008 0.012 Q 0.20 0.008

INCHES MILIMETERS DIM MIN MIN MAX MAX b2 0.60 0.024 2.10 0.083 e1 0.90 0.035 11

0.10

Dimension in mm/inches

X

У



0.004

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| JAPAN | USA | EU | CHINA |
|---------|----------|------------|-----------|
| CLASSⅢ | CLASSⅢ | CLASS II b | CL ACCIII |
| CLASSIV | CLASSIII | CLASSⅢ | CLASSIII |

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 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
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